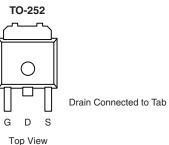


Vishay Siliconix

N-Channel 60 V (D-S), MOSFET

| PRODUCT SUMMARY | | | | | | |
|---------------------|--|---------------------------------|-----------------------|--|--|--|
| V _{DS} (V) | R_{DS(on)} (Ω) | I _D (A) ^a | Q _g (Typ.) | | | |
| 60 | 0.031 at V _{GS} = 10 V | 9.1 | 6.5 nC | | | |
| 00 | 0.045 at V _{GS} = 4.5 V | 7.6 | 0.5 110 | | | |



FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested •
- Compliant to RoHS Directive 2002/95/EC

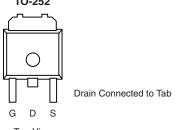
GC

APPLICATIONS

DC/DC Converters



RoHS COMPLIANT HALOGEN FREE



Ordering Information: SUD23N06-31-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

D

| ABSOLUTE MAXIMUM RATINGS | S (T _A = 25 °C, unles | ss otherwise n | oted) | |
|--|---|-----------------------------------|------------------|----|
| Parameter | Symbol | Limit | Unit | |
| Drain-Source Voltage | V _{DS} | 60 | - V | |
| Gate-Source Voltage | | V _{GS} | | |
| | T _C = 25 °C | | 21.4 | |
| Continuous Drain Current (T. -150 °C) | T _C = 70 °C | 1 | 17.1 | |
| Continuous Drain Current (T _J = 150 °C) | T _A = 25 °C | Ι _D | 9.1 ^a | |
| | T _A = 70 °C | | 7.6 ^a | А |
| Pulsed Drain Current | | I _{DM} | 50 | |
| | T _C = 25 °C | I | 20.8 | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | ۱ _S | 3.8 ^a | |
| Single Pulse Avalanche Current | L = 0.1 mH | I _{AS} | 20 | |
| Avalanche Energy | | E _{AS} | 20 | mJ |
| | T _C = 25 °C | | 31.25 | |
| Maximum Power Dissipation | T _C = 70 °C | | 20 | w |
| Maximum Fower Dissipation | T _A = 25 °C | PD | 5.7 ^a | vv |
| | T _A = 70 °C | | 3.6 ^a | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 150 | °C |

| THERMAL RESISTANCE RATINGS | | | | | | |
|--|--------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient ^a | $t \le 10 s$ | R _{thJA} | 18 | 22 | °C/W | |
| Maximum Junction-to-Case | Steady State | R _{thJC} | 3.2 | 4.0 | 0/10 | |

Notes:

a. Surface mounted on 1" x 1" FR4 board, t \leq 10 s.

SUD23N06-31

Vishay Siliconix



| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|-------------------------|---|------|-------|-------|-------|--|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$ | 60 | | | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | 1 050 14 | | 65 | | mV/°C | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = 250 μA | | - 6.3 | | | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$ | 1.0 | | 3.0 | V | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | | ± 100 | nA | |
| Zara Cata Valtaga Drain Current | | $V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | | | 1 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 70 ^{\circ}\text{C}$ | 2 | | 20 | - μΑ | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$ | 50 | | | A | |
| Drain Course On State Desistance | | V _{GS} = 10 V, I _D = 15 A | | 0.025 | 0.031 | Ω | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = 4.5 V, I _D = 10 A | | 0.037 | 0.045 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 15 A | | 20 | | S | |
| Dynamic ^b | | · | | | | | |
| Input Capacitance | C _{iss} | | | 670 | | pF | |
| Output Capacitance | C _{oss} | V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz | | 140 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 60 | | | |
| Total Cata Charge | 0 | $V_{DS} = 30$ V, $V_{GS} = 10$ V, $I_{D} = 23$ A | | 11 | 17 | nC | |
| Total Gate Charge | Qg | | | 6.5 | 13 | | |
| Gate-Source Charge | Q _{gs} | $V_{DS} = 30$ V, $V_{GS} = 4.5$ V, $I_{D} = 23$ A | | 3.0 | | nC | |
| Gate-Drain Charge | Q _{gd} | | | 3.0 | | | |
| Gate Resistance | Rg | f = 1 MHz | | 1.6 | 3.2 | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 18 | 30 | | |
| Rise Time | t _r | V_{DD} = 30 V, R_L = 1.3 Ω | | 250 | 400 | | |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong 23$ A, V_{GEN} = 4.5 V, R_g = 1 Ω | | 35 | 55 | | |
| Fall Time | t _f | | | 68 | 110 | | |
| Turn-On Delay Time | t _{d(on)} | | | 8 | 15 | ns | |
| Rise Time | t _r | V_{DD} = 30 V, R_L = 1.3 Ω | | 15 | 25 | | |
| Turn-Off Delay Time | t _{d(off)} | $\text{I}_\text{D}\cong$ 23 A, V_GEN = 10 V, R_g = 1 Ω | | 30 | 45 | | |
| Fall Time | t _f | | | 25 | 40 | | |
| Drain-Source Body Diode Characteris | tics | | | | | | |
| Continuous Source-Drain Diode Current | ۱ _S | T _C = 25 °C | | | 20.8 | ^ | |
| Pulse Diode Forward Current ^a | I _{SM} | | | | 50 | A | |
| Body Diode Voltage | V _{SD} | I _S = 15 A | | 1.0 | 1.5 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | | | 30 | 60 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | 35 | 70 | nC | |
| Reverse Recovery Fall Time | ta | l _F = 15 A, dl/dt = 100 A/μs, T _J = 25 °C | | 20 | | | |
| Reverse Recovery Rise Time | t _b | | | 10 | | ns | |

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

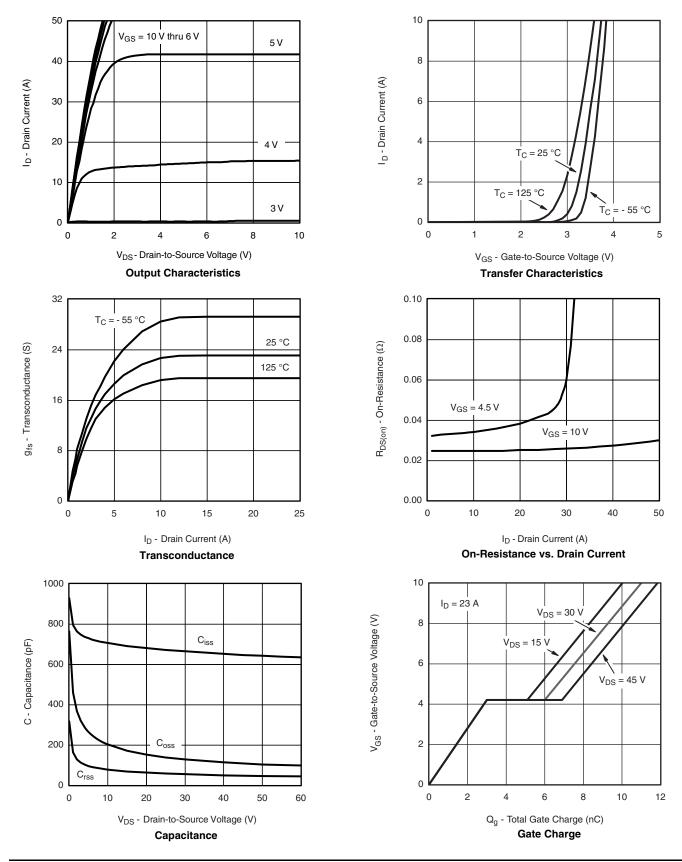
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



SUD23N06-31 Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



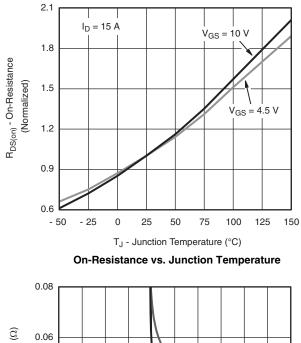
Document Number: 68857 S11-0181-Rev. B, 07-Feb-11

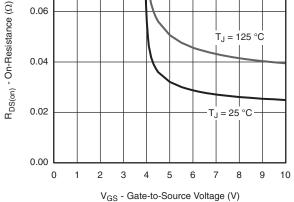
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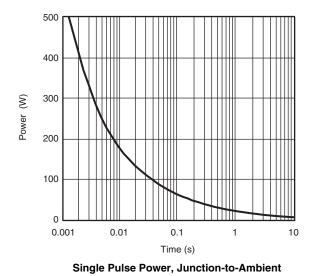
Vishay Siliconix

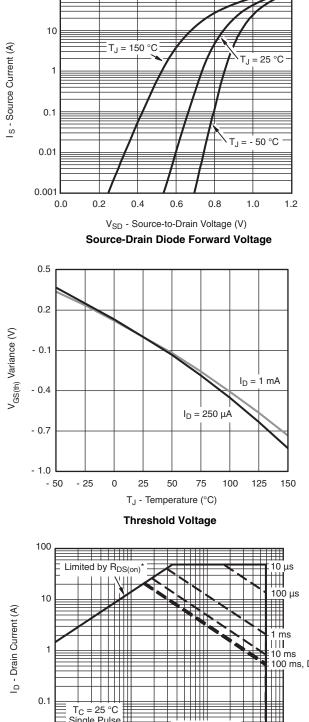
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



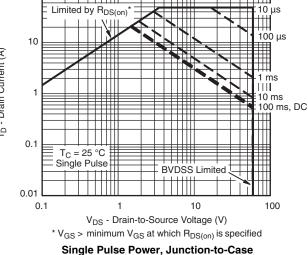








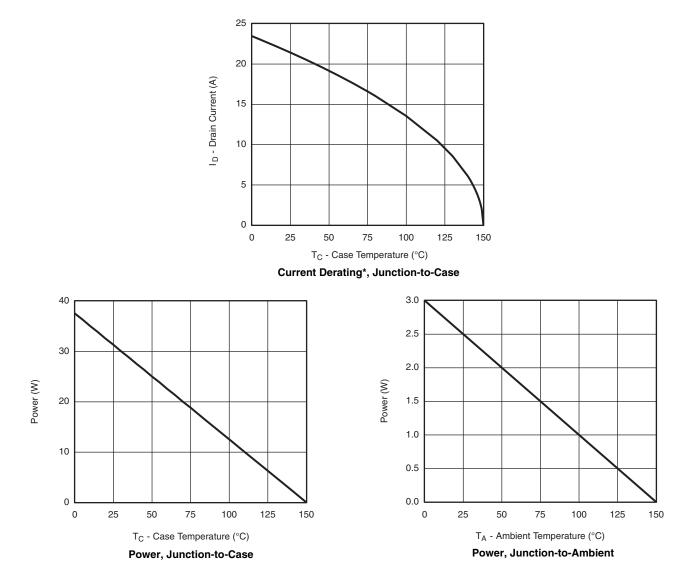
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SUD23N06-31 Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

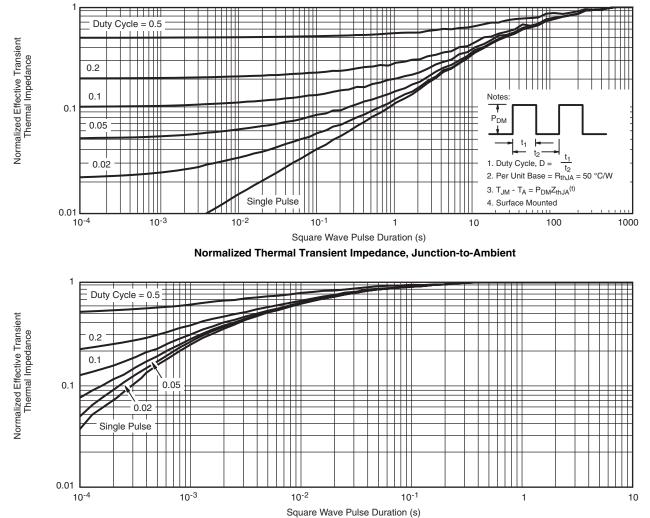


* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

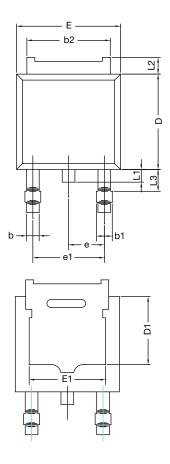
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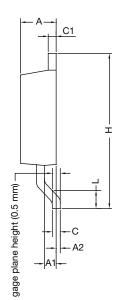


Package Information

Vishay Siliconix

TO-252AA CASE OUTLINE





| | MILLIN | IETERS | INCHES | | |
|-----------------------|--------------------------------|------------------|-----------|-------|--|
| DIM. | MIN. | MAX. | MIN. | MAX. | |
| А | 2.21 | 2.38 | 0.087 | 0.094 | |
| A1 | 0.89 | 1.14 | 0.035 | 0.045 | |
| A2 | 0.030 | 0.127 | 0.001 | 0.005 | |
| b | 0.71 | 0.88 | 0.028 | 0.035 | |
| b1 | 0.76 | 1.14 | 0.030 | 0.045 | |
| b2 | 5.23 | 5.44 | 0.206 | 0.214 | |
| С | 0.46 | 0.58 | 0.018 | 0.023 | |
| C1 | 0.46 | 0.58 | 0.018 | 0.023 | |
| D | 5.97 | 6.22 | 0.235 | 0.245 | |
| D1 | 4.10 | 4.45 | 0.161 | 0.175 | |
| E | 6.48 | 6.73 | 0.255 | 0.265 | |
| E1 | 4.49 | 5.50 | 0.177 | 0.217 | |
| е | 2.28 | .28 BSC 0.090 BS | | BSC | |
| e1 | 4.57 BSC | | 0.180 BSC | | |
| Н | 9.65 | 10.41 | 0.380 | 0.410 | |
| L | 1.40 | 1.78 | 0.055 | 0.070 | |
| L1 | 0.64 | 1.02 | 0.025 | 0.040 | |
| L2 | 0.89 | 1.27 | 0.035 | 0.050 | |
| L3 | 1.15 | 1.52 | 0.040 | 0.060 | |
| ECN: T11- DWG: 534 | 0110-Rev. L, ⁻ 7 | 18-Apr-11 | | | |

Note

• Dimension L3 is for reference only.

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Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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